# **Specifications for Approval**

t No.:	
o.: R3216GHUGT-001	
16+LENS 绿光 LED	
te: 2018-08-02	
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ving information for your app Inspection Record Curve ■Internal Circ	■ LED Dimension
Checked by: Tom Date: 2018-08-02	Approved by: Wangxiaojun Date: 2018-08-02
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	D.: R3216GHUGT-001  2.16+LENS 绿光 LED  2.e: 2018-08-02  A   Ing information for your app Inspection Record Eurve Internal Circ In  Checked by: Tom Date: 2018-08-02



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#### **Features**

3.2mm x 1.6mm SMD LED, 1.1mm thickness

Low power consumption

Wide view angle

Package: 3000pcs/reel

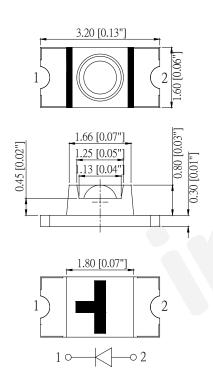
**RoHS Compliant** 

# **Applications**

Ideal for back light and indicator

Various colors and lens types available

# **Package outlines**



### **Recommend Pad Layout**





Part No.	Emitted color	Dice	Lens color
R3216GHUGT-001	Green	InGaN/GaN	Water transparent

# Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are  $\pm 0.1$ mm (0.004inch) unless otherwise noted.

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# Absolute Maximum Ratings (Ta=25°C)

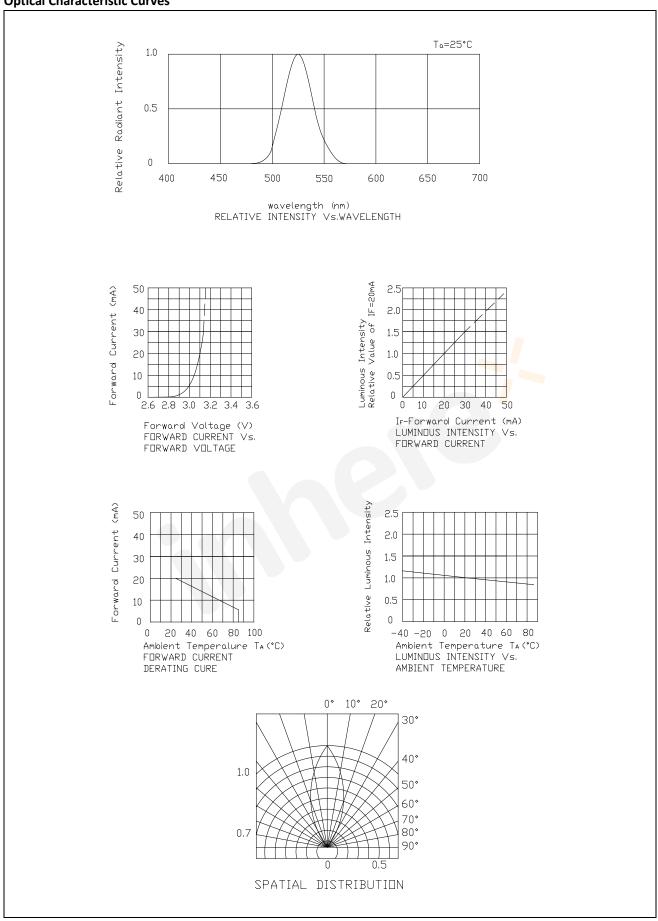
Parameter	Symbol	Value	Unit
Forward current	If	30	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	108	mW
Operating temperature	Тор	-40 ~+80	°C
Storage temperature	Tstg	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	125	mA

# Electro-Optical Characteristics (Ta=25°C)

Parameter	Test Condition		Value			
		Symbol	Min	Тур	Max	Unit
Wavelength at peak emission	If=20mA	λр		515		nm
Spectral half bandwidth	If=20mA	Δλ		35		nm
Dominant wavelength	If=20mA	λd	520		530	nm
Forward voltage	If=20mA	Vf	2.8		3.6	V
Luminous intensity	If=20mA	lv	1250	2450		mcd
Viewing angle at 50% lv	If=10mA	2 θ 1/2		40		Deg
Reverse current	Vr=5V	lr			10	μΑ

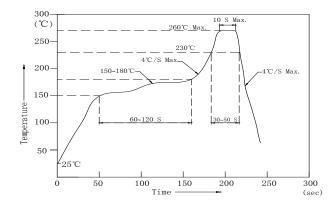
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#### **Optical Characteristic Curves**



#### **Reflow Profile**

#### ■ Reflow Temp/Time



#### Notes:

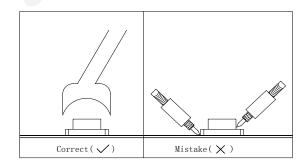
- 1. We recommend the reflow temperature 245  $^{\circ}$ C (±5  $^{\circ}$ C).the maximum soldering temperature should be limited to 260  $^{\circ}$ C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

### ■Soldering iron

Basic spec is  $\leq$  5sec when 320°C (±20°C). If temperature is higher, time should be shorter (+10°C $\rightarrow$  -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 350°C.

#### **■**Rework

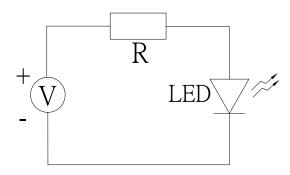
- 1. Customer must finish rework within 5 sec under 340°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

### Test circuit and handling precautions

#### ■ Test circuit



# ■ Handling precautions

# 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

2.2 Shelf life in sealed bag: 12 month at  $<5^{\circ}\text{C}^{\sim}30^{\circ}\text{C}$  and <30% R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at  $\leq$  20 R.H. with zip-lock sealed.

#### 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

 $3.1 60\pm3$ °C x ( $12^24hrs$ ) and <5%RH, taped reel type

3.2 100±3°C x (45min~1hr), bulk type

3.3 130±3°C x (15~30min), bulk type

# **Test Items and Results of Reliability**

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5 ℃ ,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5°C 30±1min ↑→(25°C/5±1min)↓ 100±5°C 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=- $40\pm5$ $^{\circ}$ C $\sim$ 100 $\pm5$ $^{\circ}$ C, 15 $\pm$ 1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5°C ~65±5°C, 90±5%RH,24hrs/1cycle GB/T 2423.4-2008		10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5°C,ψ(%)=85±5%RH GB/T 2423.3-2006		1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating GB/T 2423.2-2008		1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5 °C ,non-operating GB/T 2423.1-2008		1000hrs	0/22
Life Test	Ta=26±5°C,@20mA, ψ(%)=25%RH~55%RH		1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5˚C ,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

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# Forward Voltage Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
Н	2.8	2.9	
I	2.9	3.0	
J	3.0	3.1	
К	3.1	3.2	
L	3.2	3.3	V
М	3.3	3.4	
N	3.4	3.5	
0	3.5	3.6	

Luminous Intensity Rank Combination (IF=20mA)

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Rank	Min.	Max.	Unit
U	1250	1600	
V	1600	2000	
W	2000	2500	m od
Х	2500	3200	mcd
Υ	3200	4000	
Z	4000	-	

Dominant wavelength Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
Gk	520	522	
Gl	522	524	
Gm	524	526	nm
Gn	526	528	
Go	528	530	

Group Name on Label (Example DATA: K W Gk 20)

DATA: K W Gk 20	Vf(V)	lv (mcd)	λd (nm)	Test Condition
K→W→Gk→20	2.9~3.0	2000~2500	520~522	IF=20mA

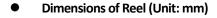
# Notes:

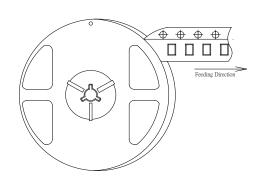
- 1. The tolerance of luminous intensity (Iv ) is  $\pm 15\%$ .
- 2. The tolerance of dominant wavelength is  $\pm 1$ nm.
- 3. This specification is preliminary.
- 4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

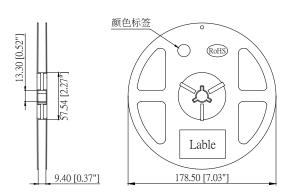
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#### 3216 Series SMD Chip LED Lamps Packaging Specifications

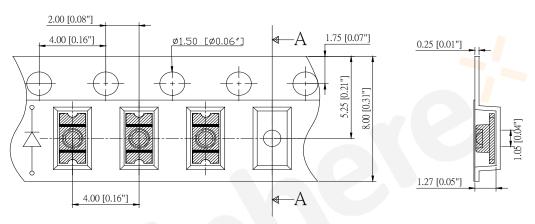
# Feeding Direction



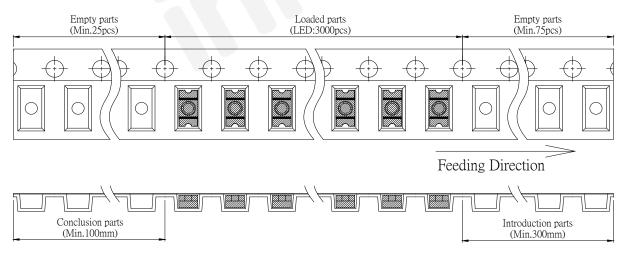




# Dimensions of Tape (Unit: mm)



# Arrangement of Tape



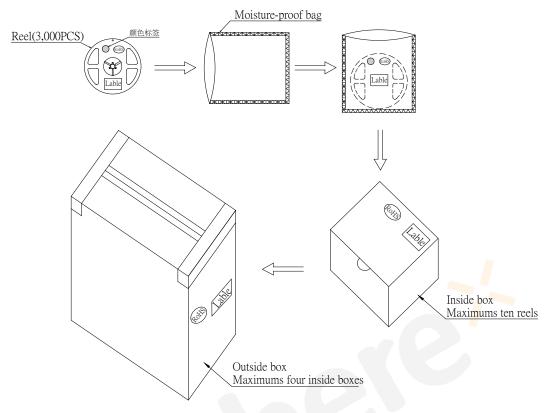
#### Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 3,000pcs/Reel.

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#### 3216 Series SMD Chip LED Lamps Packaging Specifications

# Packaging specifications



Notes:

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 30,000pcs) packed in an inside box (about size: 240x 230x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x 260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.

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